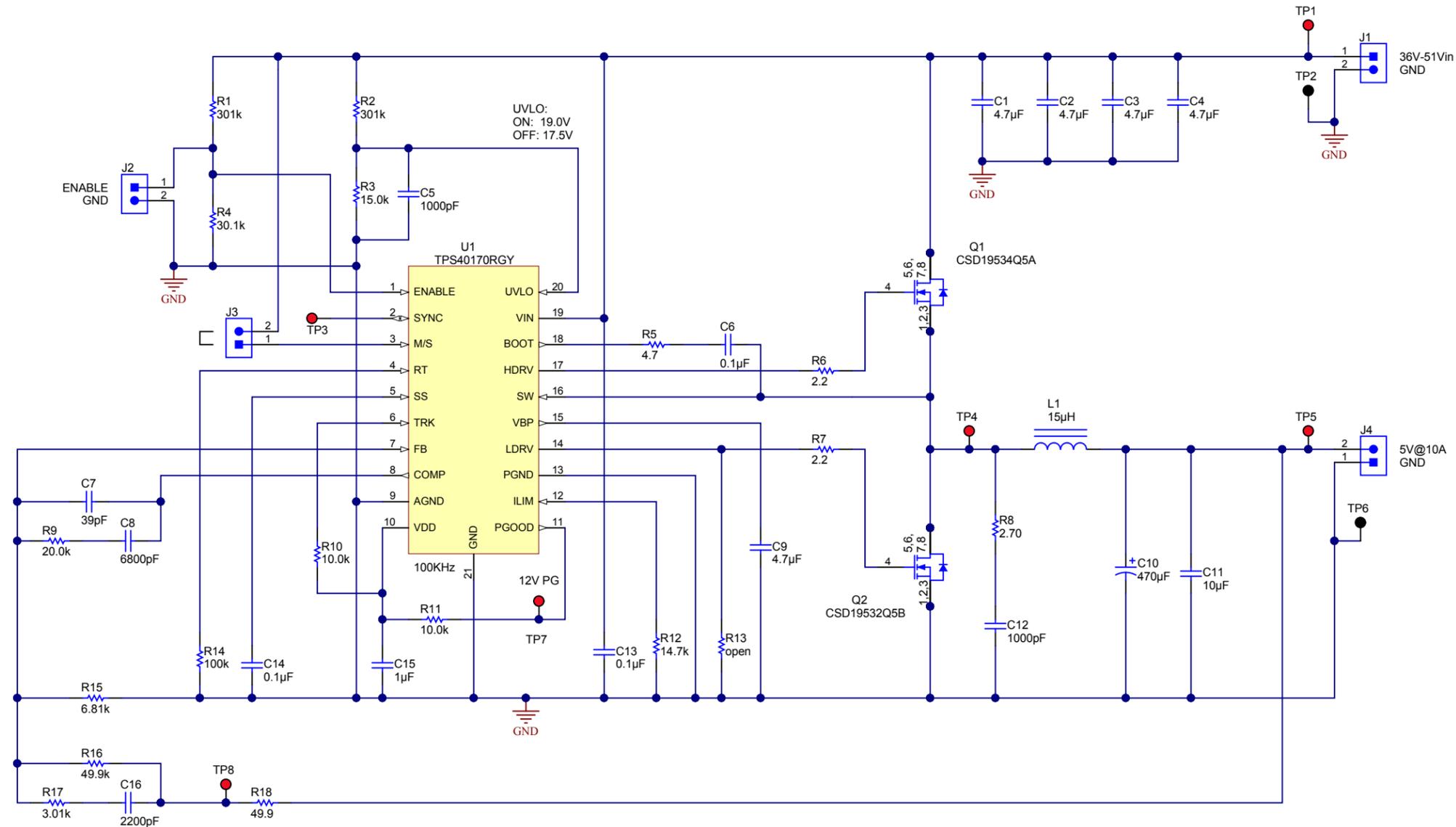


NOTES:  
 1) Preliminary design only.  
 2) Ref Des match PMP10799 REVA PWB.



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Orderable: N/A	Designed for: Public Release	Mod. Date: 5/19/2015
TID #:	Project Title: TPS40170 Sync Buck	
Number: PMP11099	Rev: B	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP11099 REVB.SchDoc	Size: B
Engineer: J Betten	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



1 2 3 4 5 6

A

A

B

B

C

C

D

D

1 2 3 4 5 6

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